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**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**  
Patent Application

Inventor(s): **Frank Kuo**

Group Art Unit:

Filed: **02/27/04**

Examiner:

Application No.: **Not yet assigned**

Title: **ENCAPSULATION METHOD AND LEADFRAME FOR LEADLESS SEMICONDUCTOR PACKAGES**

**Form 1449**

**U.S. Patent Documents**

Examiner Initial	No.	Patent No.	Date	Patentee	Class	Sub-class	Filing Date
<b>PO</b>	A	5,645,864	07/08/97	Higuchi	425	116	04/25/96
	B	6,319,450	11/20/01	Chua et al.	264	272.17	07/12/99
	C	5,052,907	10/01/91	Matumoto et al.	425	116	07/03/90
	D	6,214,273	04/10/01	Liang et al.	264	272.14	11/10/98
	E	5,672,550	09/30/97	Tsuji et al.	437	219	01/10/96
<b>AD</b>	F	4,900,501	02/13/90	Saeki et al.	264	272.17	10/30/86

**Foreign Patent or Published Foreign Patent Application**

Examiner Initial	No.	Document No.	Publication Date	Country or Patent Office	Class	Sub-class	Translation	
<b>PO</b>	G	JP2000031180A	01/28/00	JPO	H01L021	56	Yes	No
<b>AD</b>	H	JP358128745A	08/01/83	JPO	H01L021	56	Yes	No

**Other Documents**

Examiner Initial	No.	Author, Title, Date, Place (e.g. Journal) of Publication
	I	
Examiner	<b>AD</b> Date Considered <b>3/2006</b>	

Examiner: Initial citation considered. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.